

**Electrodeposition of adherent copper film on unmodified tungsten**

Wang, Chen; Lei, Jipu; Bjelkevig, Cameron; **Rudenja, Sergei**; Magtoto, Noel; Kelber, Jeff Thin solid films 2003 / 1, p. 72-79 : ill  
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**The effects of an iodine surface layer on Ru reactivity in air and during Cu**

Liu, J.; Lei, J.; Magtoto, Noel; **Rudenja, Sergei** Journal of the Electrochemical Society 2004 / 2, p. ?  
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